

Fig. 1

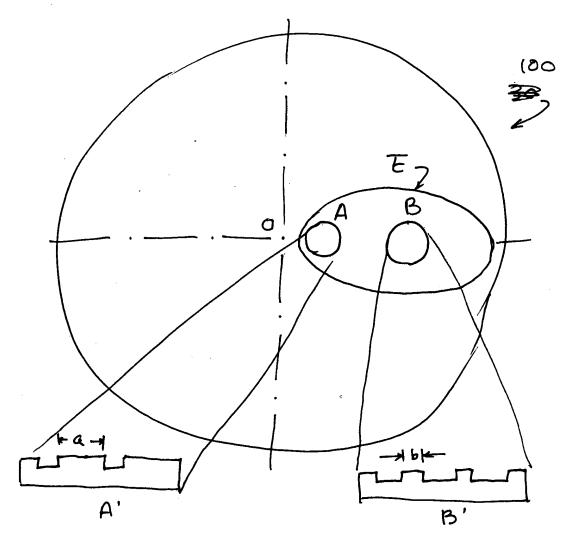
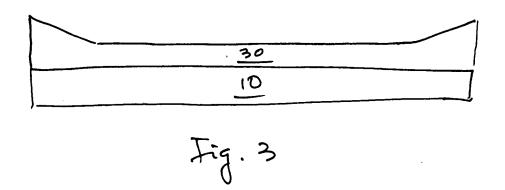


Fig. 2



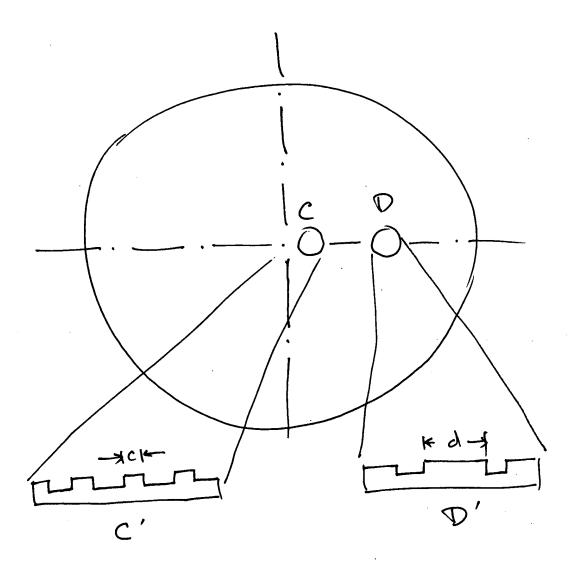


Fig 4

Start Providing awafer with known topography Selecting a polishing Pad for comp Providing a cmp Recipe Polishing Wefer end of polishing 600

Fy. 5